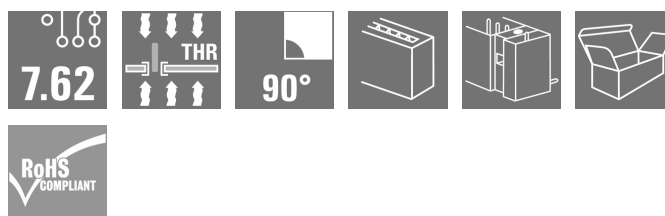


SV-SMT 7.62HP/03/90MF3 SC/4 2.6SN BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com**Product image**

OMNIMATE Power BV / SV 7.62HP Hybrid – for power, signals and EMC

Three functions in one!

The OMNIMATE Power Hybrid connector provides developers and users with the perfect three-in-one solution.

This hybrid motor connector simultaneously unites power, signals and pluggable EMC shield support. Thus you save space on the PCB, on the outer side of the housing, and in the electrical cabinet. The self-snapping one-handed interlock mechanism requires only one plugging step and thus speeds up installation and maintenance procedures. It is easy to handle and interlocks automatically – even in difficult installation positions. The unique shielding shape and slender 30° wire entry enable a space savings of up to 10 cm between rows.

General ordering data

Version	PCB plug-in connector, male header, closed side, Middle flange, THT/THR solder connection, 7.62 mm, Number of poles: 3, 90°, Solder pin length (l): 2.6 mm, tinned, black, Box
Order No.	2529770000
Type	SV-SMT 7.62HP/03/90MF3 SC/4 2.6SN BX
GTIN (EAN)	4050118539677
Qty.	48 pc(s).
Product data	IEC: 1000 V / 41 A UL: 300 V / 33 A
Packaging	Box

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Technical data

Dimensions and weights

Depth	28.3 mm	Depth (inches)	1.114 inch
Height	14 mm	Height (inches)	0.551 inch
Height of lowest version	11.4 mm	Width	39.07 mm
Width (inches)	1.538 inch	Net weight	9.63 g

System specifications

Product family	OMNIMATE Power - series BV/SV 7.62HP	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	7.62 mm
Pitch in inches (P)	0.3 "	Outgoing elbow	90°
Number of poles	3	Number of solder pins per pole	2
Solder pin length (l)	2.6 mm	Solder pin length tolerance	+0.1 / -0.3 mm
Solder pin dimensions	0.8 x 1.0 mm	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolerance (D)+ 0,1 mm		L1 in mm	22.86 mm
L1 in inches	0.9 "	L2 in mm	3.81 mm
L2 in inch	0.15 "	Number of rows	1
Pin series quantity	1	Touch-safe protection acc. to DIN VDE 57 106	safe to back of hand above the printed circuit board
Touch-safe protection acc. to DIN VDE 0470	IP 20	Volume resistance	2.00 mΩ
Can be coded	Yes	Plugging force/pole, max.	12 N
Pulling force/pole, max.	7 N		

Material data

Insulating material	PA 9T	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	II
Comparative Tracking Index (CTI)	≥ 500	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 4...6 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 4...6 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	130 °C	Temperature range, installation, min.	-25 °C
Temperature range, installation, max.	130 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	41 A
Rated current, max. number of poles (Tu=20°C)	41 A	Rated current, min. number of poles (Tu=40°C)	41 A
Rated current, max. number of poles (Tu=40°C)	41 A	Rated voltage for surge voltage class / pollution degree II/2	1,000 V
Rated voltage for surge voltage class / pollution degree III/2	630 V	Rated voltage for surge voltage class / pollution degree III/3	630 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	6 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	6 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	6 kV	Short-time withstand current resistance	3 x 1s with 420 A

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Technical data

Rated data acc. to UL 1059

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated voltage (Use group D / UL 1059) 600 V

Rated current (Use group C / UL 1059) 33 A

Clearance distance, min. 6.9 mm

Reference to approval values
Specifications are maximum values, details - see approval certificate.

Rated voltage (Use group C / UL 1059) 300 V

Rated current (Use group B / UL 1059) 33 A

Rated current (Use group D / UL 1059) 5 A

Creepage distance, min. 9.6 mm

Packing

Packaging	Box	VPE length	338 mm
VPE width	130 mm	VPE height	33 mm

Technical data - hybrid

Pitch in mm (hybrid)	nominal	3.81 mm
	Hybrid component	Signal
Pitch in mm (Signal)	3.81 mm	
Pitch in inch (hybrid)	Hybrid component	Signal
	nominal	0.15 "
Pitch in inches (Signal)	0.15 "	
Pole count (hybrid)	nominal	4
	Hybrid component	Signal
Number of poles (Signal)	4	
Number of solder pins per pole (hybrid)	Hybrid component	Signal
	nominal	1
Number of solder pins per pole (Signal)	1	
Solder pin dimensions (hybrid)	Hybrid component	Signal
	Solder pin dimensions	0.8 x 0.8 mm
Solder pin dimensions (Signal)	0.8 x 0.8 mm	
Solder pin dimensions = d tolerance (hybrid)	Hybrid component	Signal
		Lower tolerance with prefix (reveals minimum) -0,03
	Solder pin dimensions = d tolerance	Upper tolerance with prefix (reveals maximum) +0,01
		Tolerance, unit mm
Solder pin dimensions = d tolerance (Signal)	-0,03 / +0,01 mm	
Diameter of solder eyelet (hybrid)	Hybrid component	Signal
	nominal	1.3 mm
PCB hole diameter (Signal)	1.3 mm	
Tolerance of the diameter of the solder eyelet (hybrid)	Hybrid component	Signal
	Solder eyelet hole diameter tolerance (D)	± 0.1 mm
PCB hole diameter tolerance (Signal)	± 0.1 mm	
L2 in mm	3.81 mm	
L2 in inch	0.15 "	
Number of rows (hybrid)	Hybrid component	Signal
Number of rows (Signal)	2	

Creation date May 8, 2025 8:09:36 PM CEST

Catalogue status 26.04.2025 / We reserve the right to make technical changes.

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Technical data

Contact material (hybrid)	Hybrid component	Signal		
	Contact material	CuMg		
Contact material (Signal)	CuMg			
Contact surface (hybrid)	Hybrid component	Signal		
	Contact surface	tinned		
Contact surface (Signal)	tinned			
Layer structure of the solder connection (hybrid)	Layer structure of the solder connection	Layer strength	min.	1 µm
			max.	3 µm
		Material	Ni	
		Layer strength	min.	4 µm
			max.	8 µm
	Material	Sn		
Hybrid component	Signal			
Layer structure of the solder connection (Signal)	1-3 µm Ni / 4-8 µm Sn			
Layer structure of the plug contact (hybrid)	Layer structure of the plug contact	Layer strength	min.	1 µm
			max.	3 µm
		Material	Ni	
		Layer strength	min.	4 µm
			max.	8 µm
	Material	Sn		
Hybrid component	Signal			
Layer structure of the plug contact (Signal)	1-3 µm Ni / 4-8 µm Sn			
Rated voltage for overvoltage class / pollution severity level II/2 (hybrid)	Hybrid component	Signal		
	nominal	320 V		
Rated voltage for overvoltage class/pollution severity level II/2 (Signal)	320 V			
Rated voltage for overvoltage class / pollution severity level III/2 (hybrid)	Hybrid component	Signal		
	nominal	160 V		
Rated voltage for overvoltage class/pollution severity level III/2 (Signal)	160 V			
Rated voltage for overvoltage class / pollution severity level III/3 (hybrid)	Hybrid component	Signal		
	nominal	160 V		
Rated voltage for overvoltage class/pollution severity level III/3 (Signal)	160 V			
Rated impulse voltage for overvoltage class / pollution severity level II/2 (hybrid)	Hybrid component	Signal		
	nominal	2.5 kV		
Rated impulse voltage for overvoltage class/pollution severity level II/2 (Signal)	2.5 kV			
Rated impulse voltage for overvoltage class / pollution severity level III/2 (hybrid)	Hybrid component	Signal		
	nominal	2.5 kV		
Rated impulse voltage for overvoltage class/pollution severity level III/2 (Signal)	2.5 kV			
Rated impulse voltage for overvoltage class / pollution severity level III/3 (hybrid)	Hybrid component	Signal		
	nominal	2.5 kV		
Rated impulse voltage for overvoltage class/pollution severity level III/3 (Signal)	2.5 kV			
Short-time withstand current capacity (hybrid)	Hybrid component	Signal		
	Short-time withstand current resistance	3 x 1s with 80 A		
Short-time withstand current resistance (Signal)	3 x 1s with 80 A			
Creepage distance (hybrid)	Hybrid component	Signal		
	min.	4.38 mm		

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Technical data

Clearance distance (hybrid)	Hybrid component	Signal
	min.	3.6 mm
Rated voltage (Use group B / CSA) (Hybrid)	Hybrid component	Signal
	nominal	300 V
Rated voltage (Use group B / CSA) (Signal)	300 V	
Rated voltage (Use group C / CSA) (Hybrid)	Hybrid component	Signal
	nominal	50 V
Rated voltage (Use group C / CSA) (Signal)	50 V	
Rated current (Use group B / CSA) (Hybrid)	Hybrid component	Signal
	nominal	9 A
Rated current (Use group B / CSA) (Signal)	9 A	
Rated current (Use group C / CSA) (Hybrid)	Hybrid component	Signal
	nominal	9 A
Rated current (Use group C / CSA) (Signal)	9 A	
Rated current (Use group D / CSA) (Hybrid)	Hybrid component	Signal
	nominal	9 A
Rated current (Use group D / CSA) (Signal)	9 A	
Rated voltage (Use group B / UL 1059) (Hybrid)	Hybrid component	Signal
	nominal	300 V
Rated voltage (Use group B / UL 1059) (Signal)	300 V	
Rated voltage (Use group C / UL 1059) (Hybrid)	Hybrid component	Signal
	nominal	50 V
Rated voltage (Use group C / UL 1059) (Signal)	50 V	
Rated voltage (Use group D / UL 1059) (Hybrid)	Hybrid component	Signal
	nominal	300 V
Rated voltage (Use group D / UL 1059) (Signal)	300 V	
Rated current (Use group B / UL 1059) (Hybrid)	Hybrid component	Signal
	nominal	5 A
Rated current (Use group B / UL 1059) (Signal)	5 A	
Rated current (Use group C / UL 1059) (Hybrid)	Hybrid component	Signal
	nominal	5 A
Rated current (Use group C / UL 1059) (Signal)	5 A	
Rated current (Use group D / UL 1059) (Hybrid)	Hybrid component	Signal

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ETIM 9.0	EC002637
ETIM 10.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-03-01
ECLASS 13.0	27-46-03-01	ECLASS 14.0	27-46-03-01
ECLASS 15.0	27-46-03-01		

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Technical data

Environmental Product Compliance

RoHS Compliance Status	Compliant without exemption
REACH SVHC	No SVHC above 0.1 wt%

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Technical specifications refer to the power contacts • Technical data of signal contacts: 50V / 5A, stripping length 8mm • Rated current related to rated cross-section & min. No. of poles. • Specifications of diagram: P1=7.62 mm; P2=3.81 mm • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • MFX and MSFX: X= Position of the middle flange e.g. MF2, MSF3 • In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load • Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Approvals

Approvals



Approvals MAMID	https://mdcop.weidmueller.com/mediadelivery/rendition/900_319230/-T1z1mm-S800/
ROHS	Conform
UL File Number Search	UL Website
Certificate No. (cURus)	E60693

Downloads

Engineering Data	CAD data – STEP
Product Change Notification	20220105 Material change SV-SMT 7.62 20220105 Materialänderung SV-SMT
Catalogues	Catalogues in PDF-format

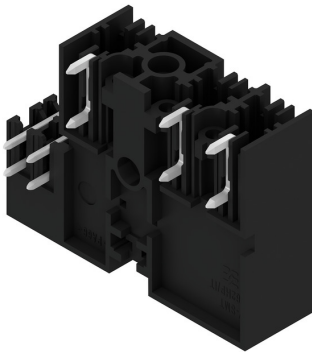
SV-SMT 7.62HP/03/90MF3 SC/4 2.6SN BX

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Klingenbergstraße 26
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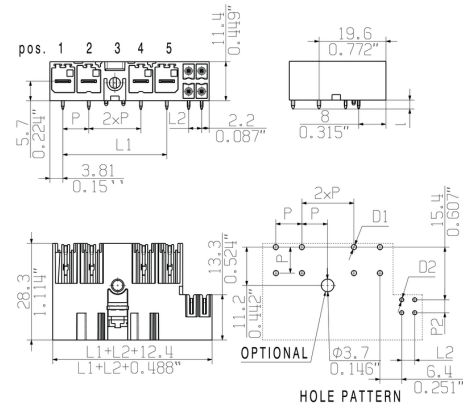
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Drawings

Product image



Dimensional drawing



Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260 °C . In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.